Vertical Cavity Surface Emitting Laser in TO-46 Package

OPV302

- 850nm VCSEL technology
- High thermal stability
- Low drive current
- High output power
- Narrow Beam Angle

The OPV302 is a Vertical Cavity Surface Emitting Laser (VCSEL) packaged in a dome lens TO-46 package. VCSELs offer many advantages in sensing applications when compared to infrared LEDs. These devices require substantially lower drive currents to obtain the same amount of output power as LEDs. This feature allows VCSELs to be used in low power consumption applications such as battery operated equipment.

The dome lens packaging creates a narrow beam angle from the device. Long distance applications may benefit from this feature as secondary optics may be eliminated, reducing total system cost. The OPV302 is optically and spectrally compatible with Optek's standard detector products such as the OP800 series phototransistors, OP830 series photodarlingtons and the OP910 photodiode.

Applications

Surface Non-contact position sensing • Ø^{.186} Photoelectric sensors .180 **Optical encoders** Light curtains .210 .050 M AX .190 **OPV302** VCSEL Pin Connection .030 MAX 1 VCSEL Anode 3X .500 MIN 2 VCSEL Cathode 2 1 3 No Connection 3X Ø ____ INVISIBLE LASER RADIATION AVOID EXPOSURE TO BEAM CLASS 3B LASER PRODUCT .016 PER IEC/EN 60825-1/A2:2001 10mW at 850nm lass 3B 3 Additional laser safety information can be found on the Optek website. See application bulletin #221. Classification is not marked on the device due to space limitations. See package out-Ø.100 line for centerline of optical radiance. Oper-Ø.230 ating devices beyond maximum rating may result in hazardous radiation exposure. .209 RoHS Optek

Optek reserves the right to make changes at any time in order to improve design and to supply the best product possible.

Emission

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Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Storage Temperature Range	-40° to +100° C
Operating Temperature Range	0° to +85° C
Lead Soldering Temperature [1/16 inch (1.6mm) from case for 5 sec with soldering iron]	260° C ⁽¹⁾
Maximum Forward Peak Current, Continuous	12 mA
Maximum Reverse Voltage	5 V
Maximum Forward Current, Pulsed (1µs P.W., 10% D.C.)	48mA

Electrical Characteristics (T_A = 25°C unless otherwise noted)

SYMBOL	PARAMETER	MIN	ΤΥΡ	МАХ	UNITS	CONDITIONS
Pot	Total Power Out	1.5			mW	I _F = 7 mA
I _{TH}	Threshold Current			3.0	mA	Note 2
V _F	Forward Voltage			2.2	V	I _F = 7 mA
I _R	Reverse Current			100	nA	V _R = 5 V
Rs	Series Resistance	20		55	ohms	Note 3
η	Slope Efficiency	0.28			mW/mA	Note 4
λ	Wavelength	840		860	nm	
Δλ	Optical Bandwidth			0.85	nm	
θ	Beam Divergence		4		Degrees	FWHM
$\Delta\eta/\Delta T$	Temp Coefficient of Slope Efficiency		-0.50		%/°C	(0° - 70°C), Note 4
Δλ/ΔΤ	Temp Coefficient of Wavelength		0.06		nm/°C	(0° - 70°C)
ΔI_{TH}	Temp Variance of Threshold Current		±1.0		mA	(0° - 70°C), Note 2
$\Delta V_F / \Delta T$	Temp Coefficient for Forward Voltage		-2.5		mV/°C	(0° - 70°C)

NOTES:

(1) RMA flux is recommended. Solder dwell time can be increased to 10 seconds when flow soldering.

(2) (3) Threshold Current is based on the two line intersection method specified in Telcordia GR-468-Core. Line 1 from 4 mA to 6 mA. Line 2 from 0 mA to 0.5 mA.

Series Resistance is the slope of the Voltage-Current line from 5 to 8 mA.

(4) Slope efficiency, is the slope of the best fit LI line from 5 mA to 8 mA with 0.25mA test intervals.

